

SCT3040KW7 N-channel SiC power MOSFET

| V _{DSS} | 1200V |
|------------------------------|-------|
| R _{DS(on)} (Typ.) | 40mΩ |
| Ι _D ^{*1} | 56A |
| P _D | 267W |

Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating ; RoHS compliant

Application

- Solar inverters
- DC/DC converters
- · Switch mode power supplies
- Induction heating
- Motor drives

• Absolute maximum ratings $(T_a = 25^{\circ}C)$

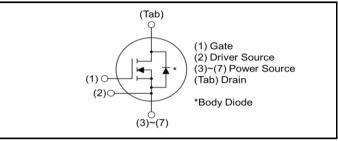
| Parameter | | Symbol | Value | Unit |
|--|----------------------|---------------------------|-------------|------|
| Drain - Source Voltage | | V _{DSS} | 1200 | V |
| $T_c = 25^{\circ}C$ | | Ι _D *1 | 56 | A |
| Continuous Drain current | $T_c = 100^{\circ}C$ | ا _D *1 | 39 | А |
| Pulsed Drain current | | I _{D,pulse} *2 | 140 | A |
| Gate - Source voltage (DC) | | V _{GSS} | -4 to +22 | V |
| Gate - Source surge voltage (t _{surge} < 300ns) | | V _{GSS_surge} *3 | -4 to +26 | V |
| Recommended drive voltage | | V _{GS_op} *4 | 0 / +18 | V |
| Junction temperature | | T _j | 175 | °C |
| Range of storage temperature | | T _{stg} | -55 to +175 | °C |

●Outline

TO-263-7L



Inner circuit



Please note Driver Source and Power Source are not exchangeable. Their exchange might lead to malfunction.

Packaging specifications

| | Packing | Embossed tape |
|------|---------------------------|---------------|
| | Reel size (mm) | 330 |
| Tuno | Tape width (mm) | 24 |
| Туре | Basic ordering unit (pcs) | 1000 |
| | Taping code | TL |
| | Marking | SCT3040KW7 |

•Electrical characteristics ($T_a = 25^{\circ}C$)

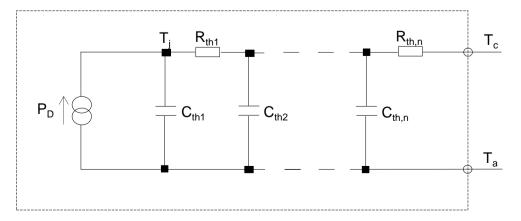
| Parameter | Symbol | Conditions | | Unit | | |
|--|------------------------|--------------------------------|------|------|------|-------|
| Faidilielei | Symbol Conditions | | Min. | Тур. | Max. | Offic |
| | | $V_{GS} = 0V, I_D = 1mA$ | | | | |
| Drain - Source breakdown voltage | V _{(BR)DSS} | T _j = 25°C | 1200 | - | - | V |
| | | T _j = -55°C | 1200 | - | - | |
| | | $V_{GS} = 0V, V_{DS} = 1200V$ | | | | |
| Zero Gate voltage Drain current | I _{DSS} | T _j = 25°C | - | 1 | 10 | μA |
| | | T _j = 150°C | - | 2 | - | |
| Gate - Source leakage current | I _{GSS+} | $V_{GS} = +22V, V_{DS} = 0V$ | - | - | 100 | nA |
| Gate - Source leakage current | I _{GSS-} | $V_{GS} = -4V$, $V_{DS} = 0V$ | - | - | -100 | nA |
| Gate threshold voltage | V _{GS (th)} | $V_{DS} = 10V, I_{D} = 10mA$ | 2.7 | - | 5.6 | V |
| | | $V_{GS} = 18V, I_{D} = 20A$ | | | | |
| Static Drain - Source on - state resistance | R _{DS(on)} *5 | $T_j = 25^{\circ}C$ | - | 40 | 52 | mΩ |
| | | T _j = 150°C | - | 68 | - | |
| Gate input resistance | R_{G} | f = 1MHz, open drain | - | 7 | - | Ω |

Thermal resistance

| Parameter | Symbol | Values | | | Unit |
|-------------------------------------|-------------------|--------|------|------|------|
| Falameter | Symbol | Min. | Тур. | Max. | Onit |
| Thermal resistance, junction - case | R _{thJC} | - | 0.44 | 0.56 | °C/W |

•Typical Transient Thermal Characteristics

| Symbol | Value | Unit | Symbol | Value | Unit |
|------------------|-----------------------|------|------------------|-----------------------|------|
| R _{th1} | 5.89×10 ⁻² | | C _{th1} | 2.17×10 ⁻³ | |
| R _{th2} | 1.79×10 ⁻¹ | K/W | C _{th2} | 1.31×10 ⁻² | Ws/K |
| R _{th3} | 1.61×10 ⁻¹ | | C _{th3} | 1.12×10 ⁻² | |





●Electrical characteristics (T_a = 25°C)

| Deremeter | Symbol | Conditions | Values | | | Linit |
|--|-------------------------------|--|--------|------|------|-------|
| Parameter | Symbol | Symbol Conditions | | Тур. | Max. | Unit |
| Transconductance | 𝔤 _{fs} ^{∗5} | $V_{DS} = 10V, I_{D} = 20A$ | - | 8.3 | - | S |
| Input capacitance | C _{iss} | $V_{GS} = 0V$ | - | 1337 | - | |
| Output capacitance | C _{oss} | V _{DS} = 800V | - | 76 | - | pF |
| Reverse transfer capacitance | C _{rss} | f = 1MHz | - | 27 | - | |
| Effective output capacitance, energy related | C _{o(er)} | $V_{GS} = 0V$ $V_{DS} = 0V$ to 600V | - | 122 | - | pF |
| Total Gate charge | Q_g^{*5} | $V_{DS} = 600V$ $I_{D} = 20A$ | - | 107 | - | |
| Gate - Source charge | Q _{gs} ^{*5} | $V_{GS} = 18V$ | - | 17 | - | nC |
| Gate - Drain charge | Q_{gd} *5 | See Fig. 1-1. | - | 56 | - | |
| Turn - on delay time | t _{d(on)} *5 | $V_{DS} = 600V$ $I_{D} = 20A$ | - | 6 | - | |
| Rise time | t _r *5 | V _{GS} = 0V/+18V | - | 19 | - | 20 |
| Turn - off delay time | t _{d(off)} *5 | $R_{G} = 0\Omega, L = 750 \mu H$ L _σ = 50nH, C _σ = 10pF | - | 29 | - | ns |
| Fall time | t _f *5 | See Fig. 2-1, 2-2, 2-3. | - | 19 | - | - |
| Turn - on switching loss | E _{on} *5 | E _{on} includes diode reverse recovery. | - | 286 | - | |
| Turn - off switching loss | ${\sf E}_{\sf off}$ *5 | | - | 69 | - | μJ |



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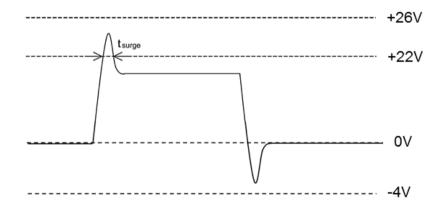
•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

| Deremeter | Symbol Conditions | Values | | | L locit | |
|--|--------------------|--|------|------|---------|------|
| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
| Body diode continuous, forward current | ا _S *1 | T _c = 25°C | - | - | 56 | А |
| Body diode direct current, pulsed | I _{SM} *2 | T _c = 25 C | - | - | 140 | А |
| Forward voltage | V_{SD} *5 | $V_{GS} = 0V, I_D = 20A$ | - | 3.2 | - | V |
| Reverse recovery time | t _{rr} *5 | $I_F = 20A$ $V_R = 600V$ | - | 25 | - | ns |
| Reverse recovery charge | Q _{rr} *5 | di/dt = 2500A/µs | - | 535 | - | nC |
| Peak reverse recovery current | ^{*5} | $L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2. | - | 35 | - | A |

*1 Limited by maximum temperature allowed.

*2 $P_W \leq$ 10µs, Duty cycle \leq 1%

*3 Example of acceptable V_{GS} waveform



Please note especially when using driver source that V_{GSS_surge} must be in the range of absolute maximum rating.

*4 Please be advised not to use SiC-MOSFETs with V_{GS} below 13V as doing so may cause thermal runaway.

*5 Pulsed



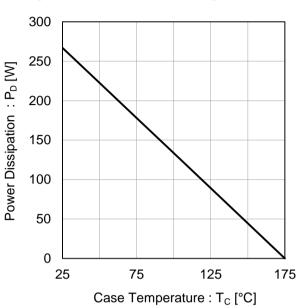
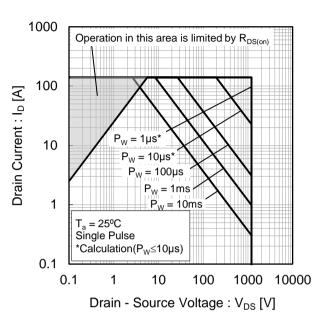
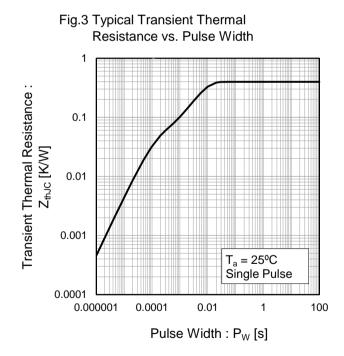


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area





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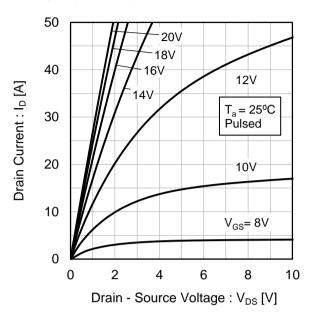


Fig.4 Typical Output Characteristics(I)

Fig.5 Typical Output Characteristics(II)

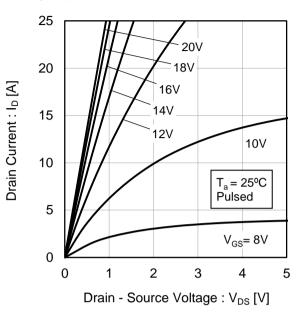
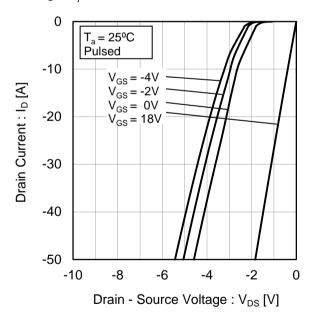
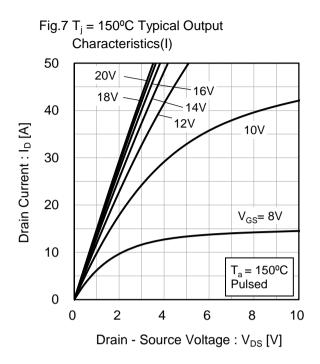


Fig.6 T_i = 25°C 3rd Quadrant Characteristics









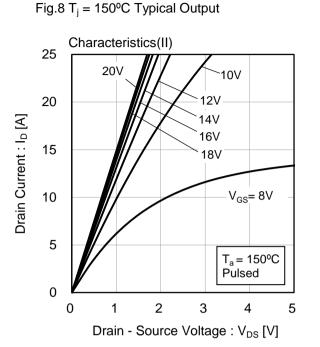
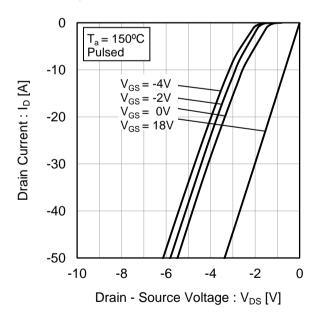
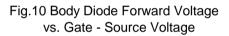
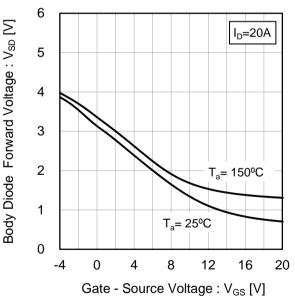


Fig.9 $T_i = 150^{\circ}C$ 3rd Quadrant Characteristics









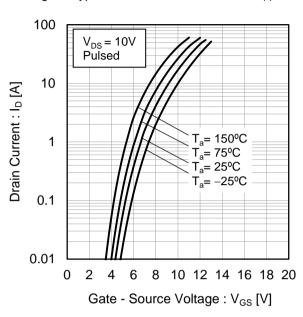
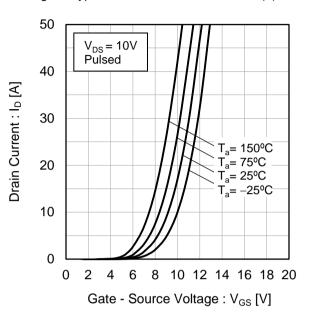


Fig.11 Typical Transfer Characteristics (I)

Fig.12 Typical Transfer Characteristics (II)



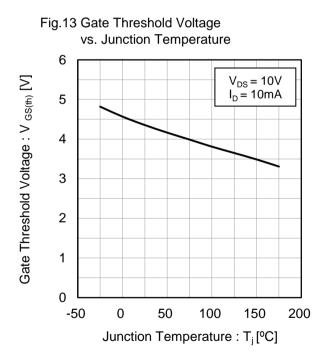
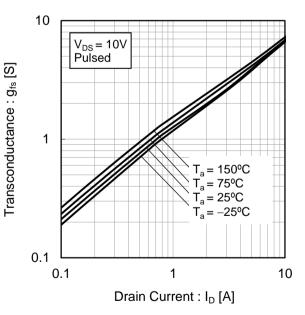


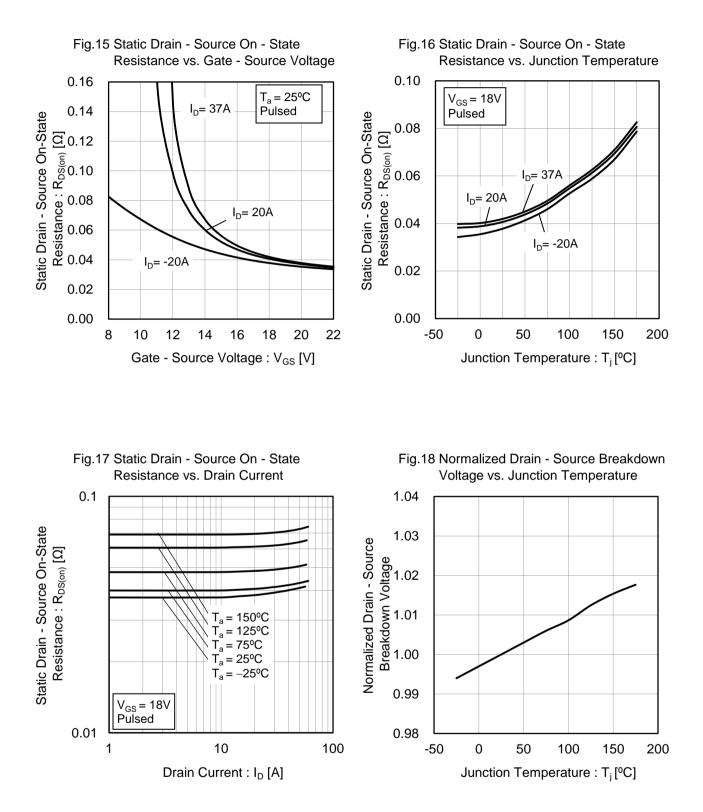
Fig.14 Transconductance vs. Drain Current

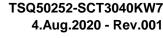


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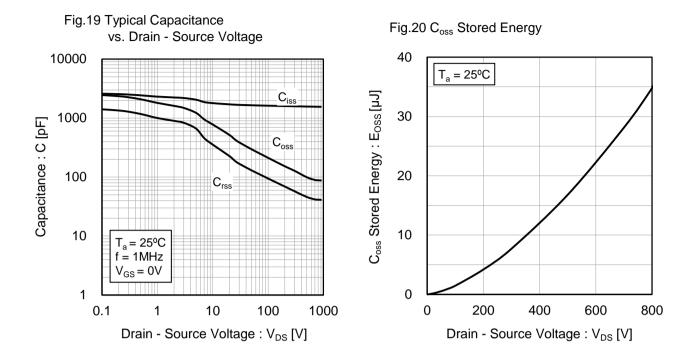
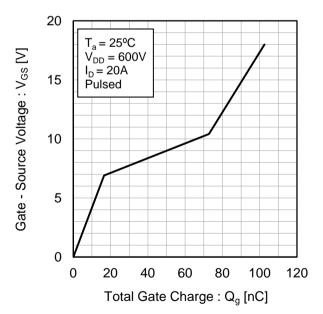
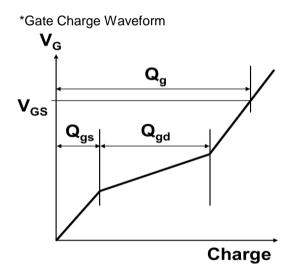
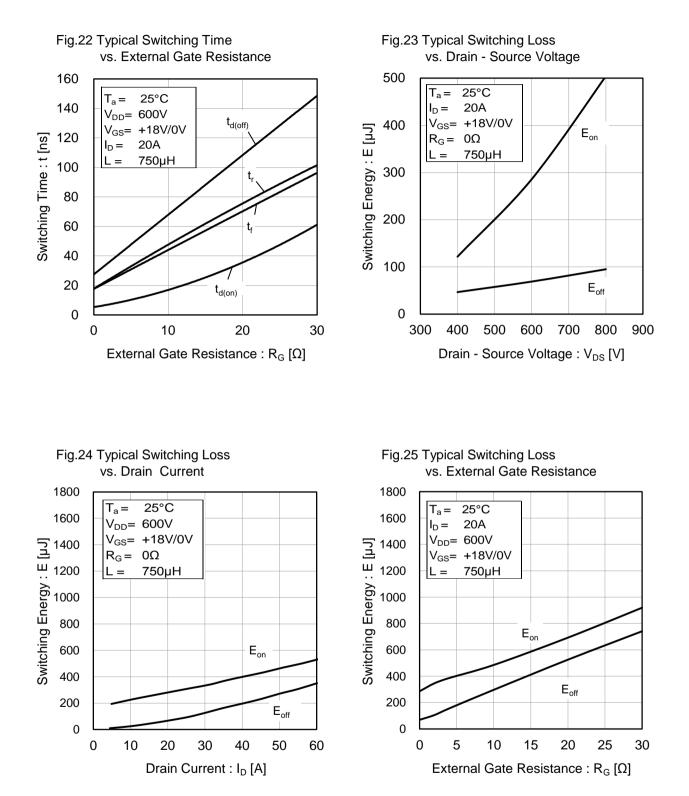


Fig.21 Dynamic Input Characteristics













Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

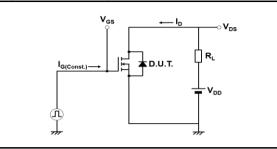


Fig.2-1 Switching Characteristics Measurement Circuit

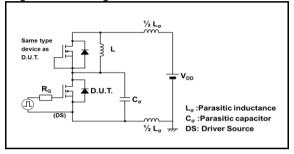


Fig.2-3 Waveforms for Switching Energy Loss

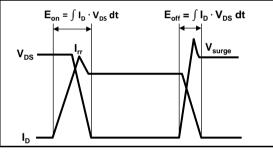


Fig.3-1 Reverse Recovery Time Measurement Circuit

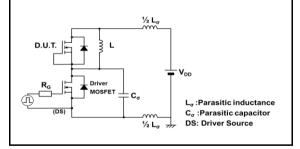


Fig.2-2 Waveforms for Switching Time

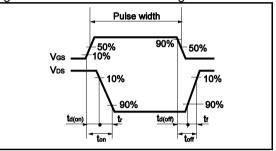
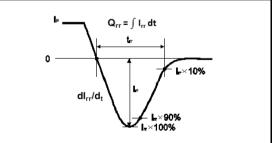


Fig.3-2 Reverse Recovery Waveform







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